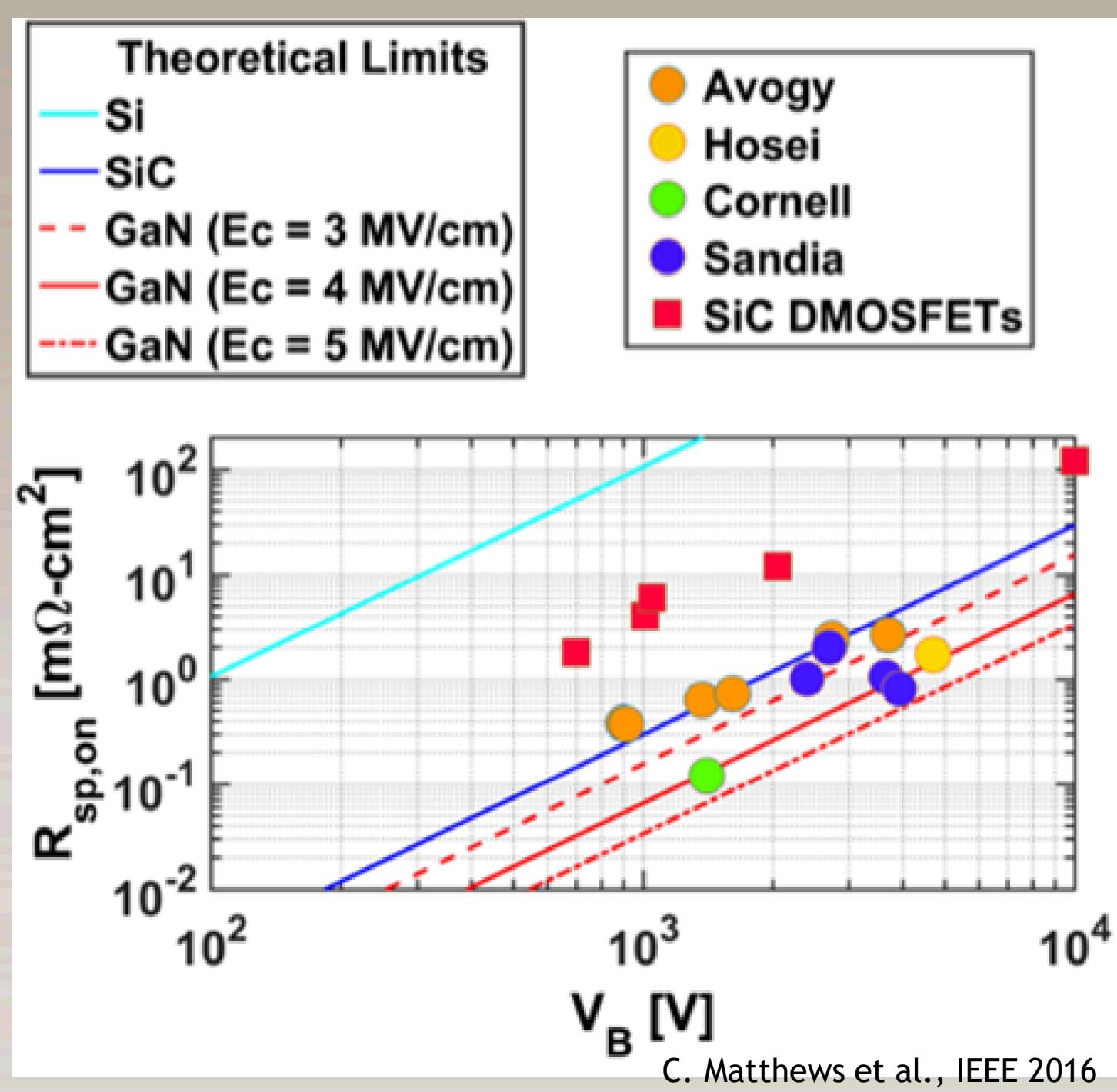


# Switching Reliability of Vertical GaN PiN Diodes

O. Slobodyan<sup>\*1</sup>, S. Sandoval<sup>2</sup>, J. Flicker<sup>1</sup>, R. Kaplar<sup>1</sup>, C. Matthews<sup>1</sup>, M. van Heukelom<sup>1</sup>, S. Atcitty<sup>1</sup>, O. Aktas<sup>3</sup>, and I. C. Kizilyalli<sup>4</sup>

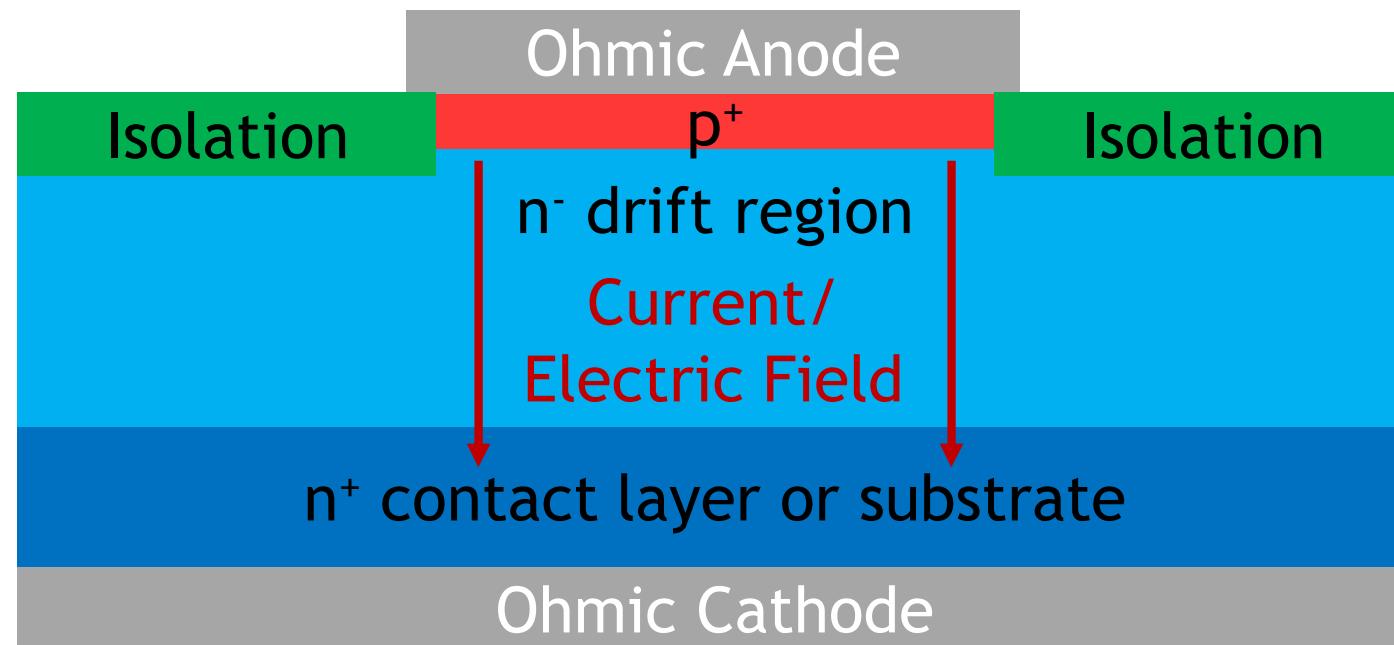
## Why Gallium Nitride?



Better material →  
Improved device performance & efficiency →  
Reduced passive component & cooling demands →  
Lower overall system cost



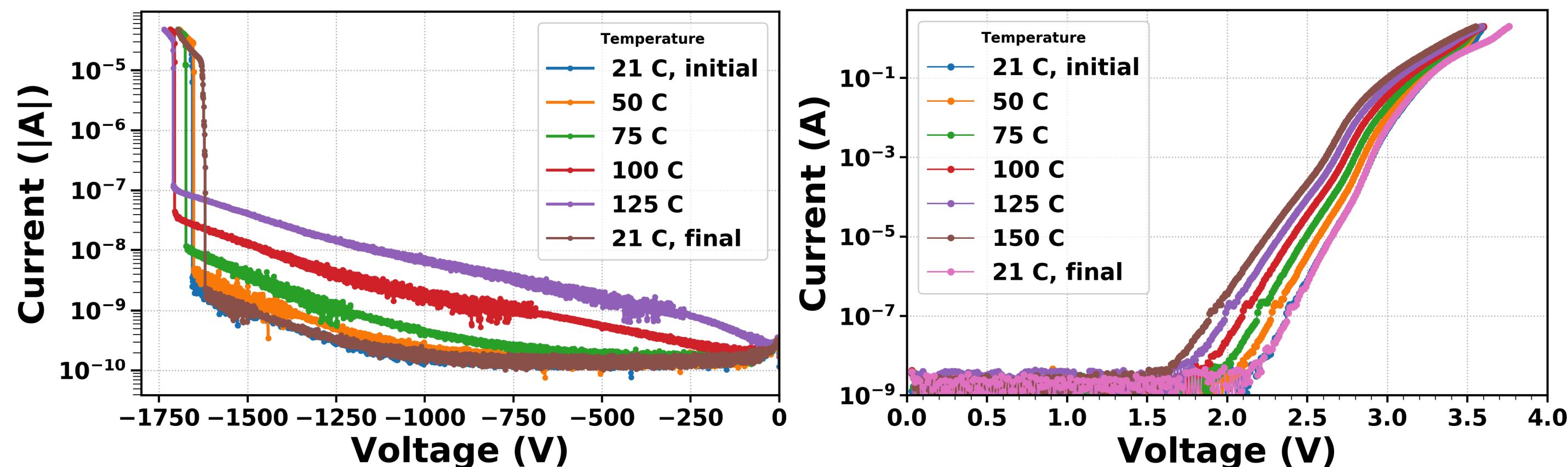
## Vertical PiN Diode



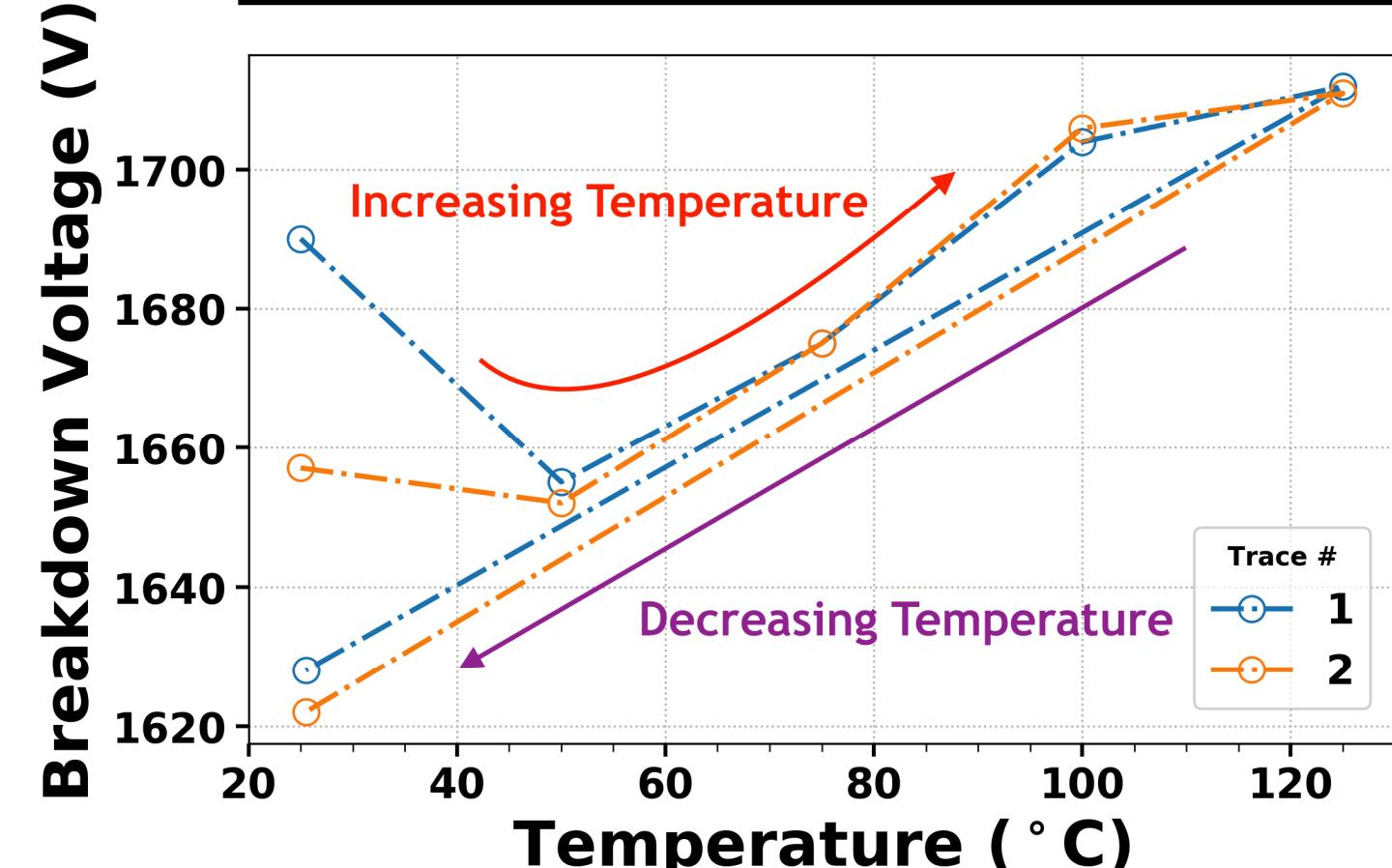
- Vertical structure offers superior electric field control
  - higher voltage and current limits

**Superior material must translate to both good device behavior and reliability**

## Current-Voltage Characterization

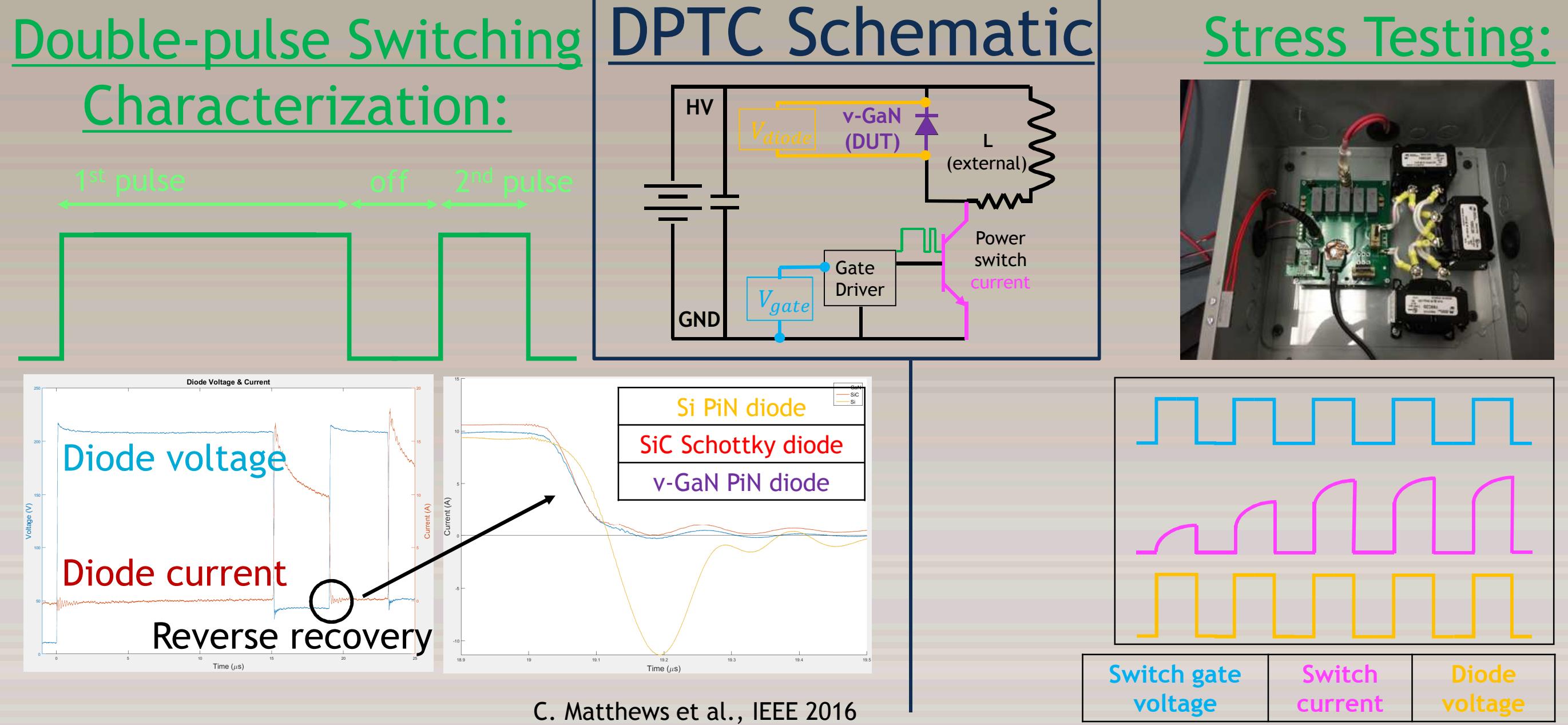


## Expected I-V wafer device performance



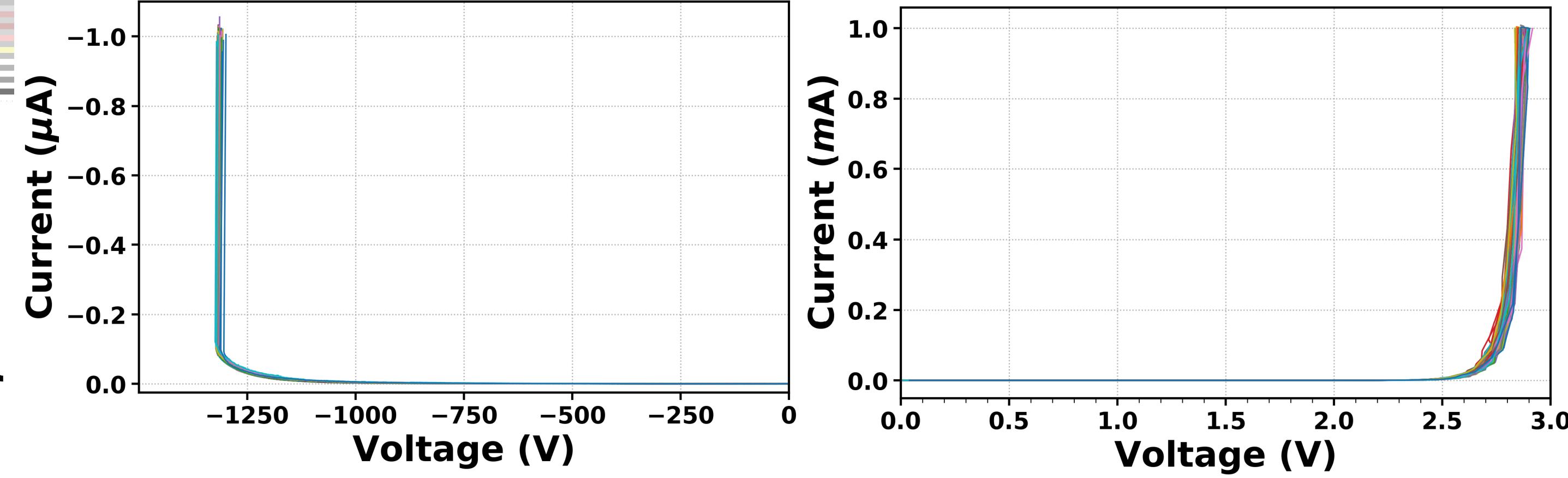
- Positive breakdown coefficient
  - avalanche process
- Breakdown hysteresis
  - evidence of burn-in effect

## Double-Pulse Test Circuit

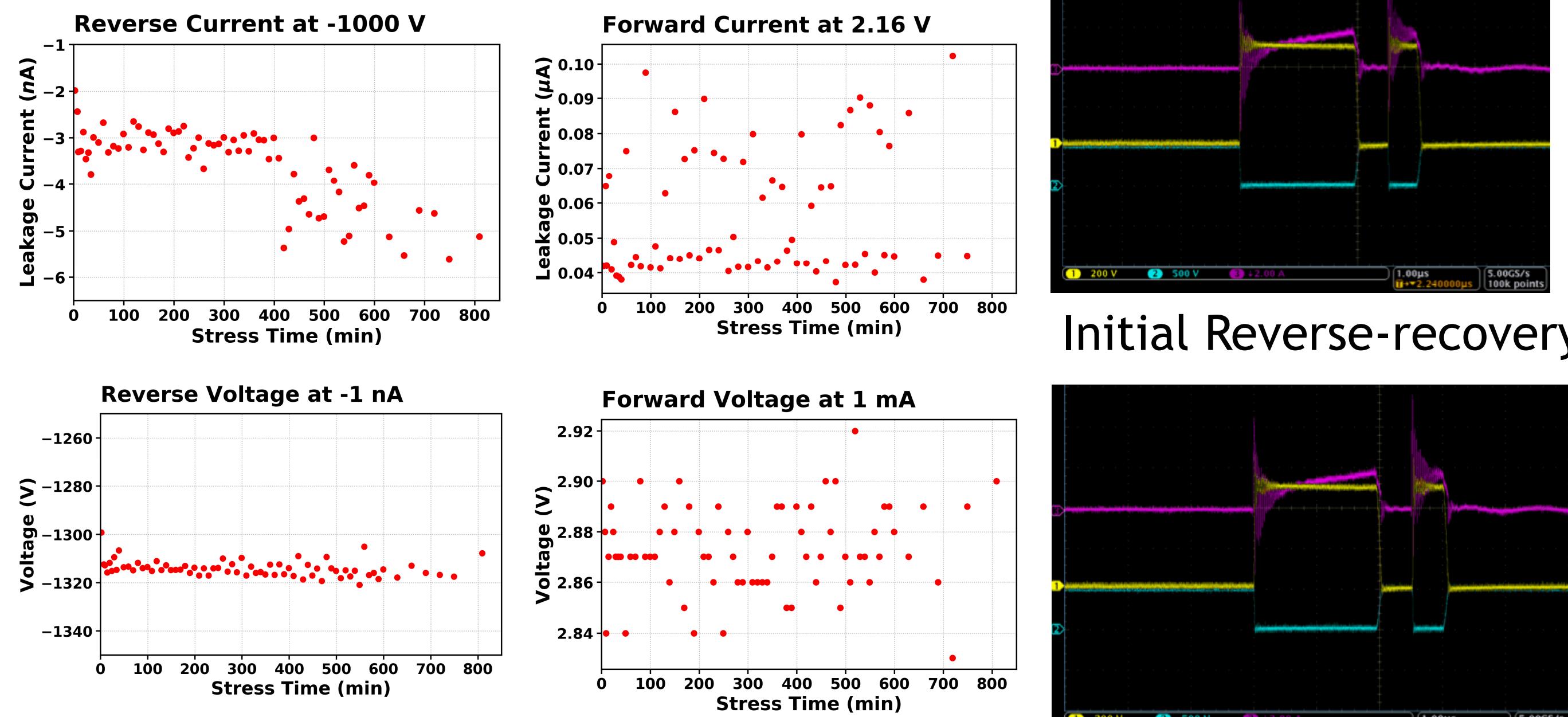


## Stress Testing Results

### Double-pulse switching stress at -500 V



### Packaged devices stable for 800 minutes of switching stress:



### Initial Reverse-recovery

### Final Reverse-recovery

## Acknowledgments

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